

PXC-M03 Dual Output Series: DC-DC Converter Module

4.5 ~ 9 VDC, 9 ~ 18 VDC, 18 ~ 36 VDC and 36~ 75 VDC input; ±5 to ±15 VDC Dual Output 3 Watts Output Power



FEATURES

- DUAL OUTPUT UP TO ±300mA
- REINFORCED INSULATION FOR 250VAC WORKING VOLTAGE
- CLEARANCE AND CREEPAGE DISTANCE :8.0mm/2MOPP
- 5000VAC INPUT TO OUTPUT 2MOPP ISOLATION
- NO MINIMUM LOAD REQUIRED
- HIGH EFFICIENCY UP TO 87.5%
- BUILT-IN EMI CLASS A FILTER
- 2µA PATIENT LEAKAGE CURRENT
- SMALL SIZE: 1.25×0.80×0.40 INCH
- 2:1 ULTRA WIDE INPUT VOLTAGE RANGE
- FIXED SWITCHING FREQUENCY
- INPUT UNDER-VOLTAGE PROTECTION
- OUTPUT OVER-VOLTAGE PROTECTION
- OVER-CURRENT PROTECTION
- OUTPUT SHORT CIRCUIT PROTECTION
- REMOTE ON/OFF
- COMPLIANT TO RoHS II & REACH



CE MARKED

SAFETY APPROVALS: ANSI/AAMI ES60601-1

EN60601-1 IEC60601-1

APPLICATIONS

- MEDICAL EQUIPMENT
- TELECOM/DATACOM
- INDUSTRY CONTROL SYSTEM
- MEASUREMENT EQUIPMENT
- SEMICONDUCTOR EQUIPMENT
- PV POWER SYSTEM
- IGBT GATE DRIVER

OPTIONS

- PIN CONNECTION
- REMOTE ON/OFF
- TRIM

GENERAL DESCRIPTIONS

The PXC-M03 series offer 3 watts of output power from a 1.25 x 0.80 x 0.40 inch package. PXC-M03 series have 2:1 wide input voltage of 4.5~9VDC, 9~18VDC, 18~36VDC and 36~75VDC. The PXC-M03 has features 5000VAC of isolation, short circuit protection, over-current protection and over-voltage protection. All models are particularly suited to IGBT isolated power supplies, measurement equipment, telecommunications, industry and medical equipment applications.



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Outp	out Specification	S			
Parameter	Model	Min	Тур	Max	Unit
Output Voltage	xxD05	4.95	5	5.05	
(Vin(nom); Full Load; Ta=25°C)	xxD12	11.88	12	12.12	VDC
	xx D15	14.85	15	15.15	
Output Regulation					
Line (Vin(min) to Vin(max); Full Load)	All	-0.5		+0.5	%
Load (0% to 100% of Full Load)		-1.0		+1.0	
Output Ripple and Noise	xxD05		30	75	
Peak to Peak (20MHz Bandwidth)	xxD12		40	100	mVp-p
With a 10µF/25V X7R MLCC	xxD15		40	100	
Cross Regulation	All	5.0			0/ -11/1
(Asymmetrical Load 25% / 100% of Full Load)	All	-5.0		+5.0	% of Vout
Voltage adjustability (see page 30)	A.II.	40		4.0	0/ ()/ /
(Only for B-type Pin connection option)	All	-10		+10	% of Vout
Temperature Coefficient	All	-0.02		+0.02	%/°C
Output Voltage Overshoot	All		0	3	% of Vout
(Vin,min to Vin,max; Full Load; Ta=25°C)	All		U	3	% OI VOUL
Dynamic Load Response					
(Vin= Vin(nom); Ta=25°C)					
Load step change from					
75% to 100% or 100 to 75% of Full Load					
Peak Deviation	All		3		% of Vout
Setting Time (Vo<10% peak deviation)	All		250		μs
Output Current	xxD05	0		±300	
	xxD12	0		±125	mA
	xxD15	0		±100	
Output Capacitance Load	xxD05			±430	
	xxD12			±75	μF
	xxD15			±56	
Output Over Voltage Protection (see page 32)	xxD05	5.6		7.0	
	xxD12	13.5		18.2	VDC
	xxD15	17		22.0	
Output Over Current Protection (see page 31)	All		150		% of FL
(% of lout rated; Hiccup mode)		_			
Output Short Circuit Protection (see page 32)	All	Co	ontinuous, aut	tomatic recove	ery



Inpu	ut Specifications				
Parameter	Model	Min	Тур	Max	Unit
Operating Input Voltage					
Continuous	05Dxx	4.5	5	9	
	12Dxx	9	12	18	
	24Dxx	18	24	36	
	48Dxx	36	48	75	VDC
Transient (3sec,max)	05Dxx			16	
	12Dxx			25	
	24Dxx			50	
	48Dxx			100	
Input Standby Current	05D05		25	100	
(Typ. value at Vin(nom); No Load)	05D12		25		
(Typ. value at vin(nonly, No Load)	05D15		25		
	12D05		10		
	12D12		10		
	12D12		10		
	24D05		6		mA
	24D12		6		
	24D15		6		
	48D05		4		
	48D12		4		
	48D15		4		
Under Voltage Lockout Turn-on Threshold	05Dxx		•	4.5	
ondor rondge zoonour rum on rimbonoid	12Dxx			9	
	24Dxx			18	VDC
	48Dxx			36	
Under Voltage Lockout Turn-off Threshold	05Dxx		4		
	12Dxx		8		
	24Dxx		16		VDC
	48Dxx		33		
Input reflected ripple current					_
(5 to 20MHz, 12µH source impedance)	All		20		mAp-p
Start Up Time					
(Vin(nom) and constant resistive load)					
Power up	All		30		ms
Remote ON/OFF			30		
Remote ON/OFF Control (see page 33)					<u> </u>
(The Ctrl pin voltage is referenced to negative input)					
Ctrl pin Low Voltage, Module ON	xxDxx- <u>P</u>		Short or 0	~ 1.2VDC	
Ctrl pin High Voltage, Module OFF				2 ~ 12VDC	
Input Current of Remote Control Pin		-0.5	OP011 01 Z.	1	mA
Remote Off State Input Current		0.0	2.5	<u>'</u>	mA
Nomoto on otato input ourient			2.0		111/7



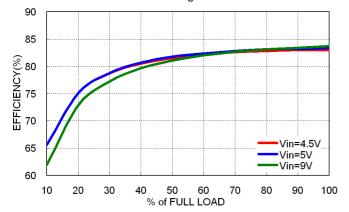
Gen	eral Specification	S				
Parameter	Model	Min	Тур	Max	Unit	
Efficiency	05D05		83			
(Vin(nom); Full Load; Ta=25°C)	05D12		86			
	05D15		86			
	12D05		83.5			
	12D12		87.5			
	12D15		86.5		%	
	24D05		83		76	
	24D12		87			
	24D15		86			
	48D05		83			
	48D12		86			
	48D15		86			
Isolation voltage (1 minute)	All				VAC	
Input to Output		5000				
Isolation capacitance	All		12	17	pF	
Leakage current (240VAC,60Hz)	All			2	μΑ	
Switching Frequency	All	135	150	165	kHz	
Clearance/Creepage	All	8			mm	
Weight	All		14.0		g	
MTBF(see page 37)	All				hours	
MIL-HDBK-217F Ta=25°C, Full load	All		6.444 x 10 ⁶		Hours	
Safety Approvals	All	ANSI/AAMI ES60601-1				
	All			, EN60601-1		
Case Material		Non-conductive black plastic				
Base Material	All	Non-conductive black plastic				
Potting Material	All		Silicone (UL94 V-0)		

Environn	nental Specifica	tions				
Parameter	Model	Min	Тур	Max	Unit	
Operating Ambient Temperature						
Without Derating	All	-40		94	°C	
With Derating		94		105		
Storage Temperature	All	-55		125	°C	
Thermal Impedance (20LFM)	All		18		°C/W	
Relative humidity	All	5		95	% RH	
Thermal Shock	All	MIL-STD-810F				
Vibration	All		MIL-STI	D-810F		

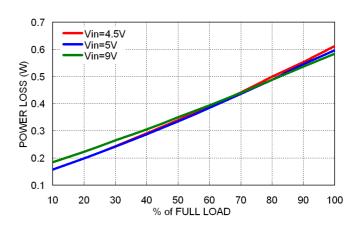
EMC	Characteristics				
Characteristic	Standard	Condi	tion	Level	
EMI	EN55011				
	EN55022	Module sta	nd-alone	Class A	
	FCC Part 18				
	EN55011				
	EN55022	With external	l input filter	Class B	
	FCC Part 18				
ESD	EN61000-4-2	Air	±8kV	Perf. Criteria A	
E3D	EIN01000-4-2	Contact	±6kV	Pen. Ciliena A	
Radiated Immunity	EN61000-4-3		10V/m	Perf. Criteria A	
Fast Transient(see page 34)	EN61000-4-4		Perf. Criteria A		
Surge(see page 34)	EN61000-4-5		±2kV	Perf. Criteria A	
Conducted Immunity	EN61000-4-6	<u> </u>	10V r.m.s	Perf. Criteria A	



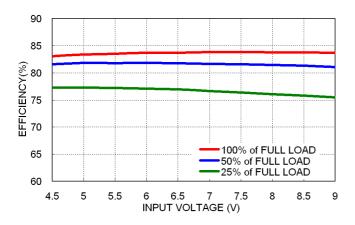
Characteristic Curves



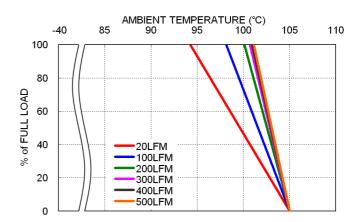
Efficiency versus Output Current



Power Dissipation versus Output Current

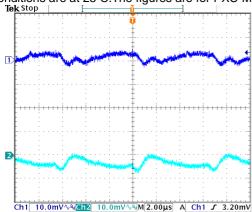


Efficiency versus Input Voltage Full Load

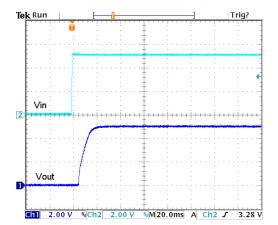


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

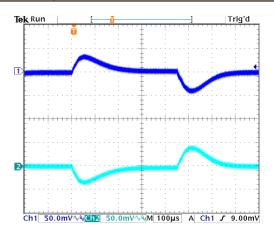




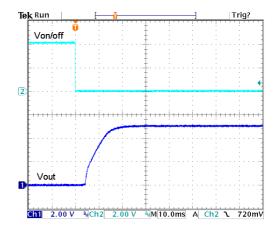
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

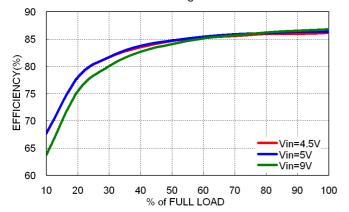


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

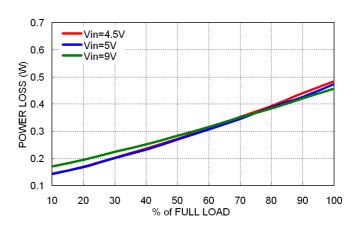


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

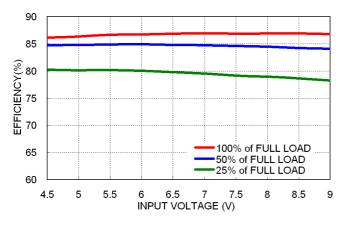




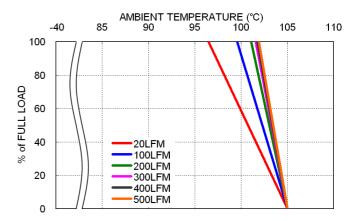
Efficiency versus Output Current



Power Dissipation versus Output Current

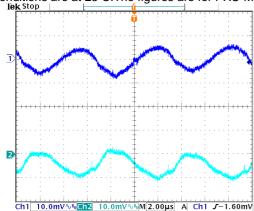


Efficiency versus Input Voltage Full Load

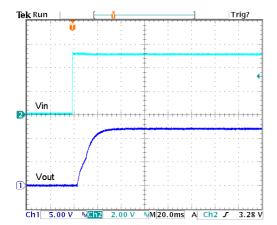


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

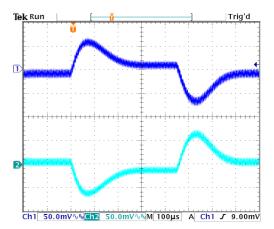




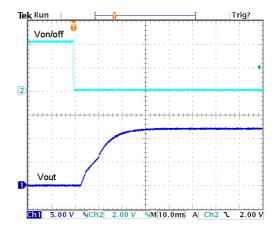
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

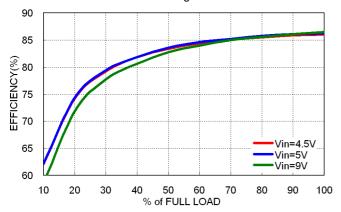


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

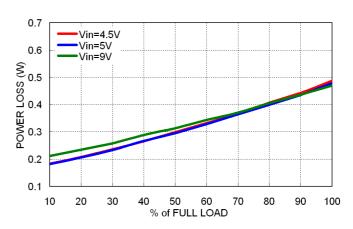


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

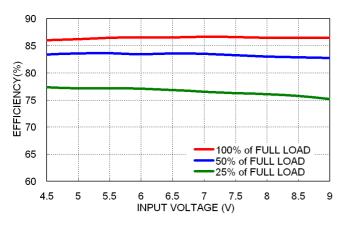




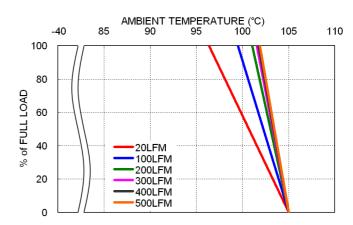
Efficiency versus Output Current



Power Dissipation versus Output Current

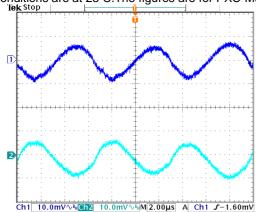


Efficiency versus Input Voltage Full Load

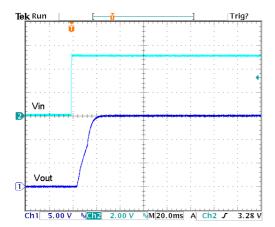


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

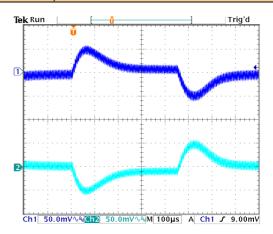




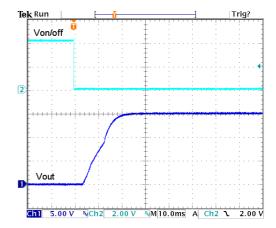
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

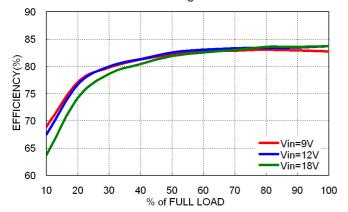


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

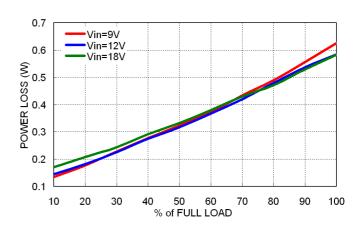


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

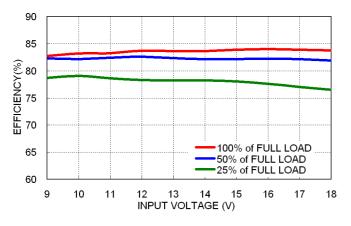




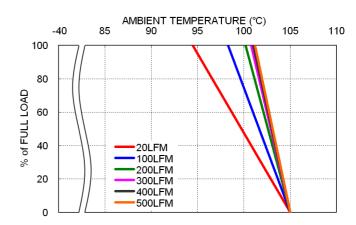
Efficiency versus Output Current



Power Dissipation versus Output Current

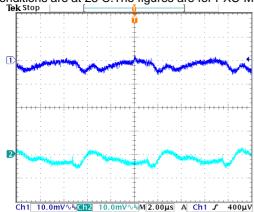


Efficiency versus Input Voltage Full Load

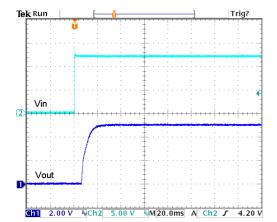


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

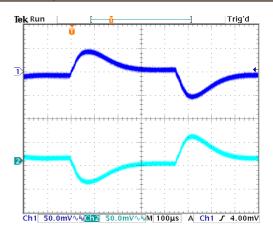




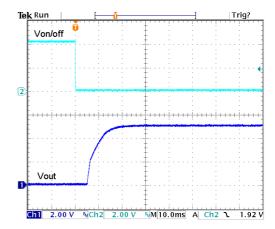
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

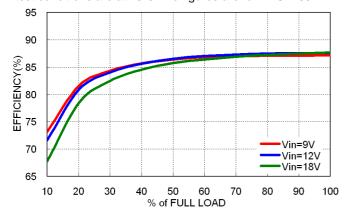


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

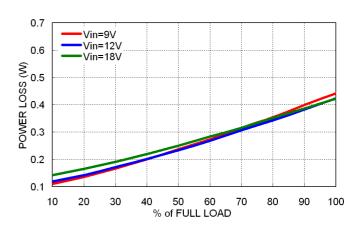


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

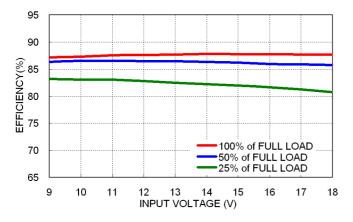




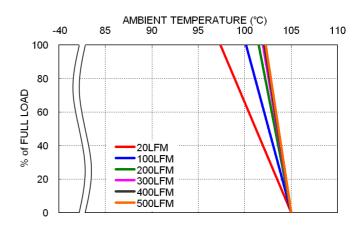
Efficiency versus Output Current



Power Dissipation versus Output Current

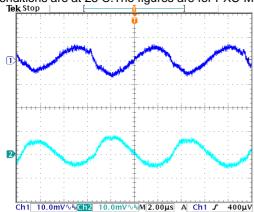


Efficiency versus Input Voltage Full Load

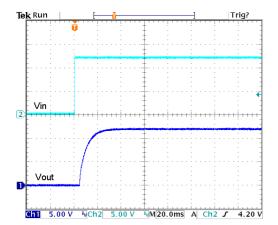


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

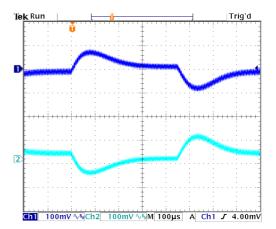




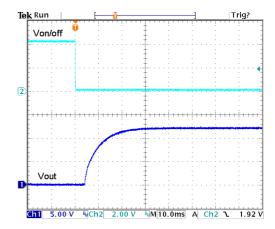
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

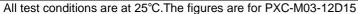


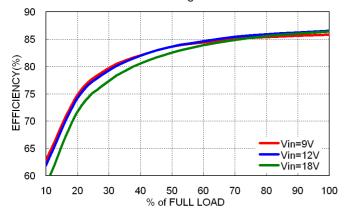
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



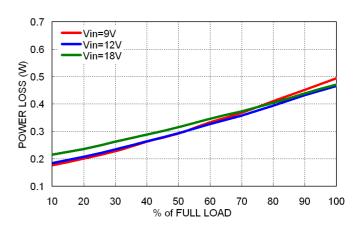
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



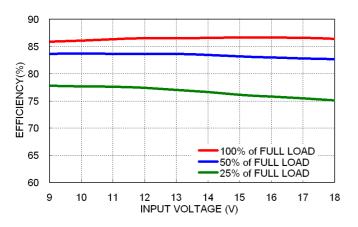




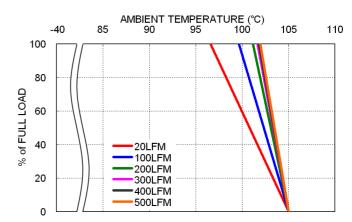
Efficiency versus Output Current



Power Dissipation versus Output Current

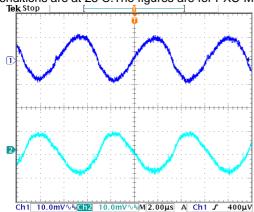


Efficiency versus Input Voltage Full Load

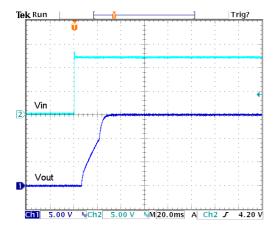


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

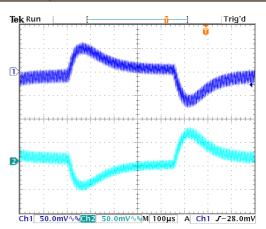




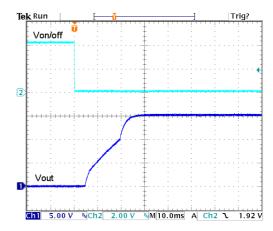
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

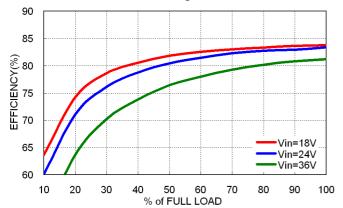


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

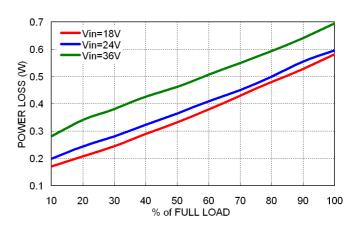


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

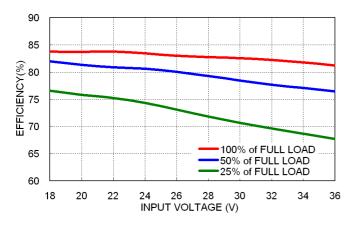




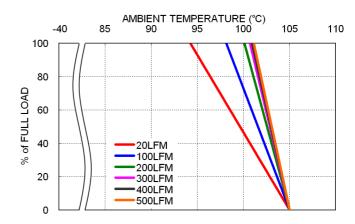
Efficiency versus Output Current



Power Dissipation versus Output Current

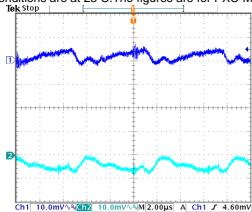


Efficiency versus Input Voltage Full Load

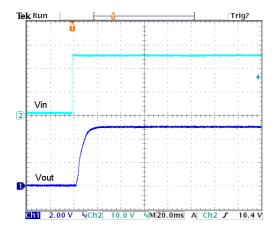


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

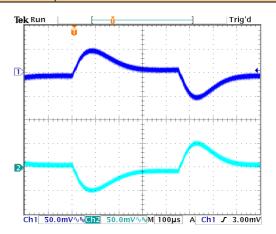




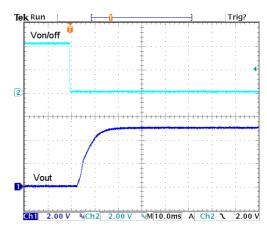
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

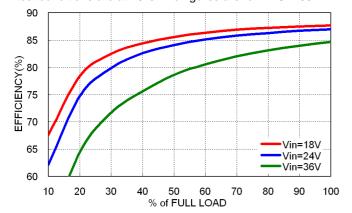


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

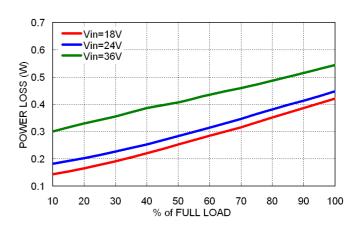


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

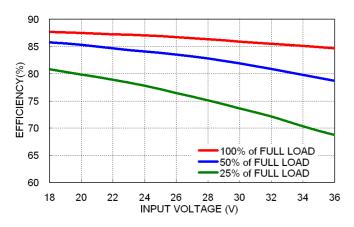




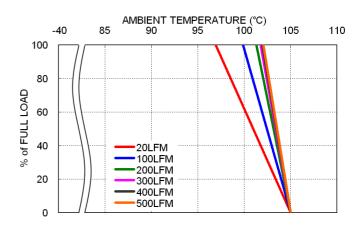
Efficiency versus Output Current



Power Dissipation versus Output Current

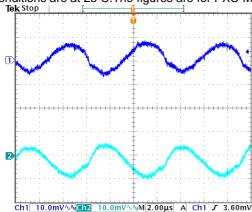


Efficiency versus Input Voltage Full Load

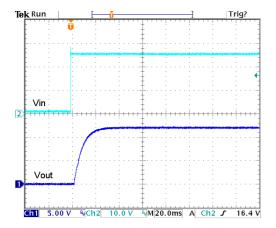


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

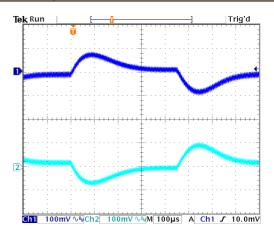




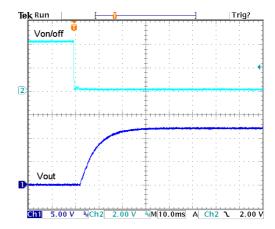
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

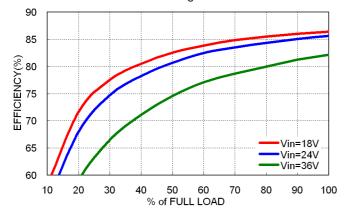


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

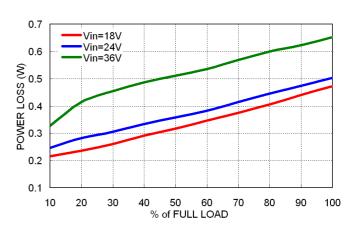


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

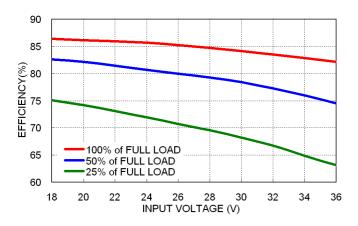




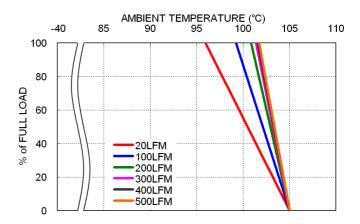
Efficiency versus Output Current



Power Dissipation versus Output Current

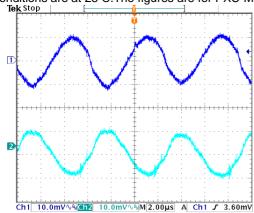


Efficiency versus Input Voltage Full Load

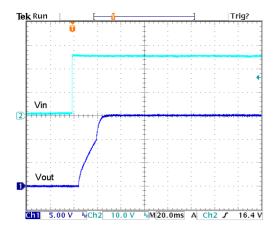


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

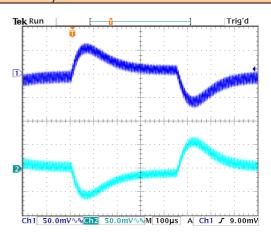




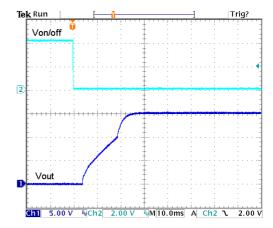
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

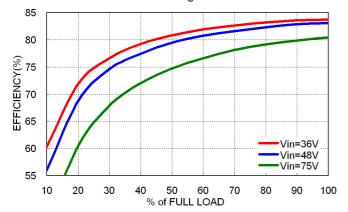


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

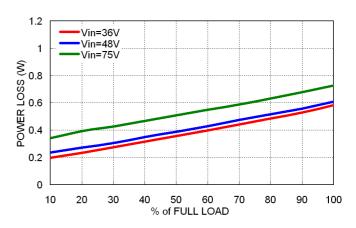


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

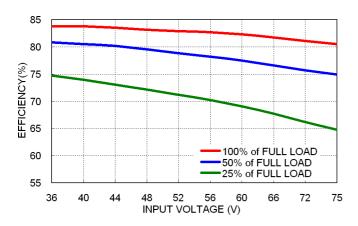




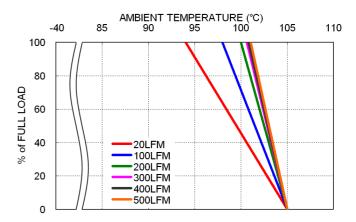
Efficiency versus Output Current



Power Dissipation versus Output Current

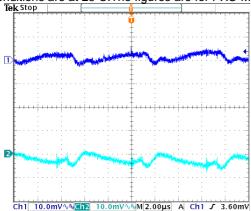


Efficiency versus Input Voltage Full Load

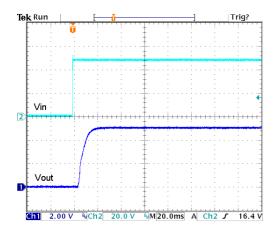


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

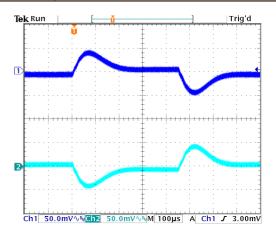




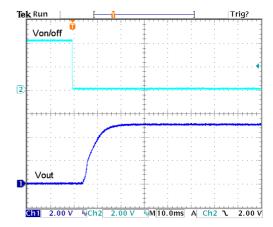
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

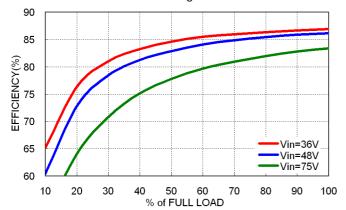


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

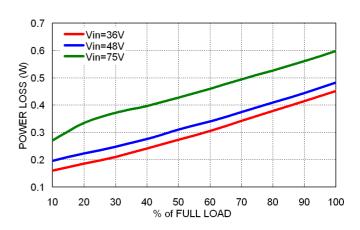


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

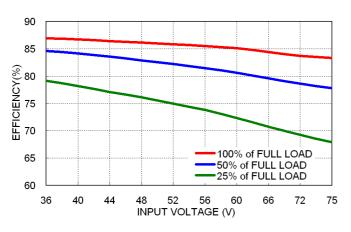




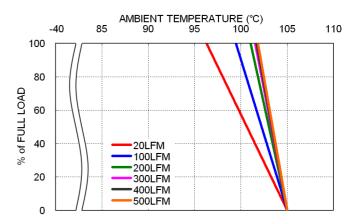
Efficiency versus Output Current



Power Dissipation versus Output Current

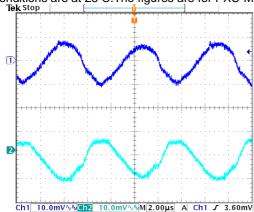


Efficiency versus Input Voltage Full Load

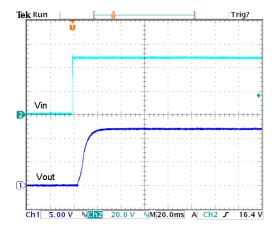


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

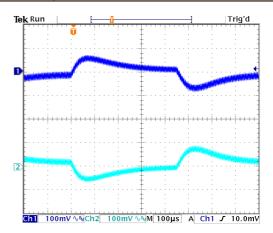




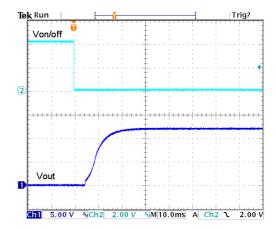
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

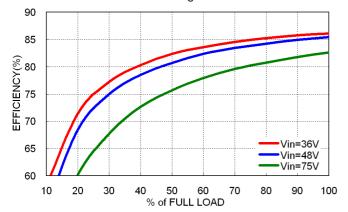


Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

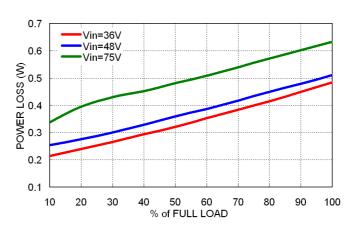


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

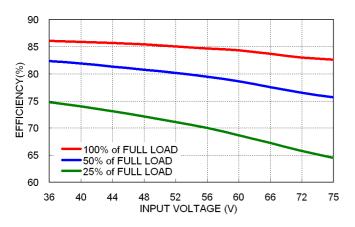




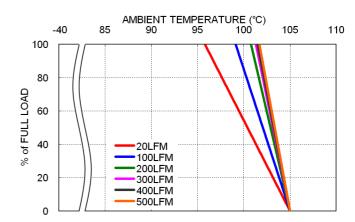
Efficiency versus Output Current



Power Dissipation versus Output Current

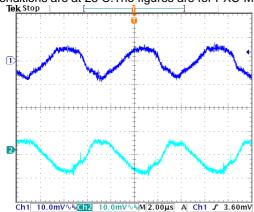


Efficiency versus Input Voltage Full Load

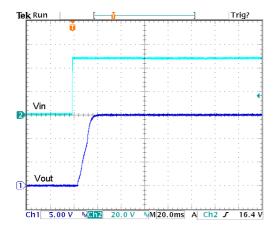


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

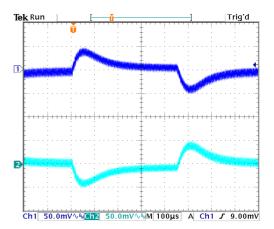




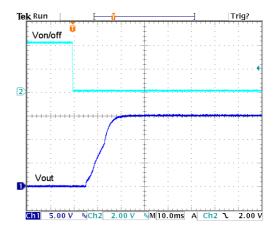
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



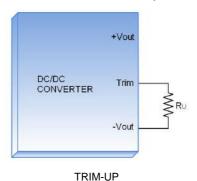
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

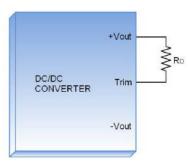


Output Voltage Adjustment

Output voltage adjustment is an optional function for PXC-M03-xxDxx-xT.

It allows the user to increase or decrease the output voltage of the module. This is accomplished by connecting an external resistor between the TRIM pin and either the +Vout or -Vout pins. With an external resistor between the TRIM and (-) OUTPUT pin, the output voltage increases. With an external resistor between the TRIM and (+) OUTPUT pin, the output voltage decreases. The external TRIM resistor needs to be at least 1/16W of rated power.





TRIM-DOWN

Output voltage adjustment configurations

TRIM TABLE

xxD05	-xT	TRIN	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	±5.047	±5.097	±5.147	±5.196	±5.246	±5.296	±5.346	±5.396	±5.446	±5.496
RU	(kΩ)	71.84	34.42	21.95	15.71	11.97	9.47	7.69	6.36	5.32	4.48

TRIM-DOWN

Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	±4.947	±4.897	±4.847	±4.797	±4.747	±4.697	±4.647	±4.597	±4.547	±4.497
RD	(kΩ)	219.16	106.58	69.05	50.29	39.03	31.53	26.17	22.14	19.02	16.52

xxD12	-xT	TRIN	/I-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	±12.113	±12.233	±12.352	±12.472	±12.592	±12.712	±12.832	±12.952	±13.072	±13.192
RU	(kΩ)	568.20	277.60	180.73	132.30	103.24	83.87	70.03	59.65	51.58	45.12

TRIM-DOWN

Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	±11.873	±11.753	±11.633	±11.513	±11.393	±11.273	±11.153	±11.033	±10.913	±10.793
RD	(kΩ)	4949.80	2440.40	1603.93	1185.70	934.76	767.47	647.97	558.35	488.64	432.88

xxD15	-xT	TRIN	/I-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	±15.131	±15.281	±15.43	±15.58	±15.73	±15.88	±16.03	±16.179	±16.329	±16.479
RU	(kΩ)	236.25	111.62	70.08	49.31	36.85	28.54	22.61	18.16	14.69	11.92

TRIM-DOWN

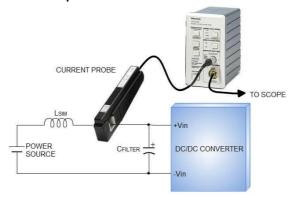
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	±14.831	±14.681	±14.532	±14.382	±14.232	±14.082	±13.932	±13.782	±13.633	±13.483
RD	(kΩ)	2707.75	1332.38	873.92	644.69	507.15	415.46	349.96	300.84	262.64	232.08



Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Install choke (LSIM) to simulate the impedance of power source. External input capacitors CFILTER serve primarily as energy-storage elements, minimizing line voltage variations caused by transient IR drops in conductors from backplane to the DC/DC. The capacitor must be as close as possible to the input terminals of the power module for lower impedance. The input reflected-ripple current measurement configuration is shown below:

Input reflected-ripple current measurement setup



PXC-M03-05Dxx

Component	Component Value		Reference	
Lsim	12µH		Inductor	
CFILTER 47µF		100V	Nippon chemi-con KY-series	

PXC-M03-12Dxx

Component	Value Voltage		Reference		
Lsim	12µH		Inductor		
CFILTER 47µF		100V	Nippon chemi-con KY-series		

PXC-M03-24Dxx

Component	Value Voltage		Reference		
Lsim	12µH		Inductor		
CFILTER 47µF		100V	Nippon chemi-con KY-series		

PXC-M03-48Dxx

Component	Value Voltage		Reference	
Lsım	12μH		Inductor	
CFILTER 47µF		100V	Nippon chemi-con KY-series	



Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all power supplies. Normally, overload current is maintained at approximately 150 percent of rated current for PXC-M03 SERIES.

Hiccup-mode is a method of operation in a power supply whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the power supply to restart when the fault is removed. There are other ways of protecting the power supply when it is over-loaded, such as the maximum current limiting or current fold-back methods.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of those devices may exceed their specified limits. A protection mechanism has to be used to prevent those power devices from being damaged.

The operation of hiccup is as follows. When the current sense circuit sees an over-current event, the controller shuts off the power supply for a given time and then tries to start up the power supply again. If the over-load condition has been removed, the power supply will start up and operate normally; otherwise, the controller will see another over-current event and shut off the power supply again, repeating the previous cycle. Hiccup operation has none of the drawbacks of the other two protection methods, although its circuit is more complicated because it requires a timing circuit. The excess heat due to overload lasts for only a short duration in the hiccup cycle, hence the junction temperature of the power devices is much lower.

The hiccup operation can be done in various ways. For example, one can start hiccup operation any time an over-current event is detected; or prohibit hiccup during a designated start-up is usually larger than during normal operation and it is easier for an over-current event is detected; or prohibit hiccup during a designated start-up interval (usually a few milliseconds). The reason for the latter operation is that during start-up, the power supply needs to provide extra current to charge up the output capacitor. Thus the current demand during start-up is usually larger than during normal operation and it is easier for an over-current event to occur. If the power supply starts to hiccup once there is an over-current, it might never start up successfully. Hiccup mode protection will give the best protection for a power supply against over current situations, since it will limit the average current to the load at a low level, so reducing power dissipation and case temperature in the power devices.

Output Short Circuitry Protection

Continuous and auto-recovery mode.

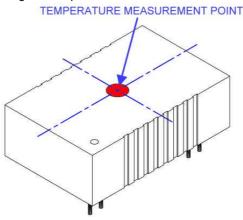
During short circuit, converter will shut down. The average current during this condition will be very low and the device is safe in this condition.

Output Over Voltage Protection

The output over-voltage protection consists of circuitry that internally clamps the output voltage. If a more accurate output over-voltage protection scheme is required then this should be implemented externally via use of the remote on/off pin.

Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as shown in the figure below. The temperature at this location should not exceed 105°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 105°C. Although the maximum point temperature of the power modules is 105°C, limiting this temperature to a lower value enhances the reliability.



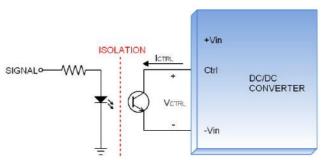


Remote On/off Control

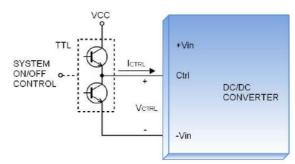
Only for B-type pin connection option with suffix -P,. Ex.: PXC-M03-24D05-P

The module is ON during logic Low and turns OFF during logic High. The Ctrl pin is an open collector/drain logic input signal that is referenced to (-)Vin. If not using the remote on/off feature, the Ctrl and (-)Vin pins should be connected together (shorted) or apply 0-1.2V between these two pins for the module to be ON.

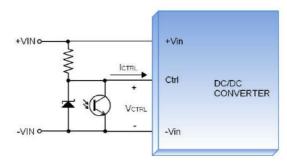
Remote ON/OFF Implementation



Isolated-Control Remote ON/OFF



Level Control Using TTL Output

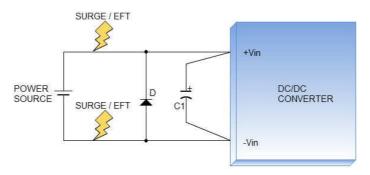


Level Control Using Line Voltage



EMS Considerations

The PXC-M03 series can meet Fast Transient EN61000-4-4 and Surge EN61000-4-5 performance criteria A with external components connected to the input terminals of the module. Please see the following schematic shown below.



Surge / Fast Transient

PXC-M03-05Dxx

Component	Value Voltage		Reference
D	10A	45V	Vishay V10P45
C1 1000µF		25V	Nippon chemi-con KY-series

PXC-M03-12Dxx

Component	Value	Voltage	Reference		
C1 470µF		50V	Nippon chemi-con KY-series		

PXC-M03-24Dxx

Component	Value	Voltage	Reference
C1	470µF	50V	Nippon chemi-con KY-series

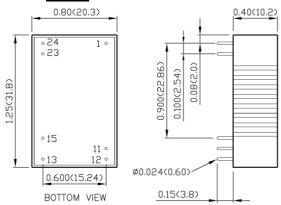
PXC-M03-48Dxx

Component	Value	Voltage	Reference		
C1	330µF	100V	Nippon chemi-con KY-series		

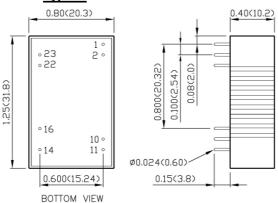


Mechanical Data

PXC-M03-xxDxx Type A



PXC-M03-xxDxx Type B



PIN CONNECTION

PIN	FUNCTION
1	+ Vin
11	Com
12	No pin
13	-Vout
15	+Vout
23	- Vin
24	- Vin

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5) X.XXX±0.01 (X.XX±0.25)

3. Pin pitch tolerance ±0.01 (0.25)

4. Pin dimension tolerance ±0.004 (0.1)

PIN CONNECTION

PIN	FUNCTION
1	Ctrl (Option) / No pin
2	- Vin
10	Trim (Option) / No pin
11	-Vout
14	+Vout
16	Com
22	+Vin
23	+Vin

*If no Ctrl or Trim option, there is no pin on the corresponding pin number.

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5) X.XXX±0.01 (X.XX±0.25)

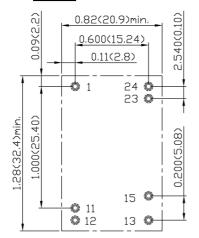
3. Pin pitch tolerance ±0.01 (0.25)

4. Pin dimension tolerance ±0.004 (0.1)

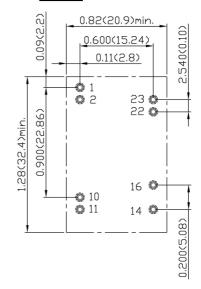


Recommended Pad Layout

PXC-M03-xxDxx Type A



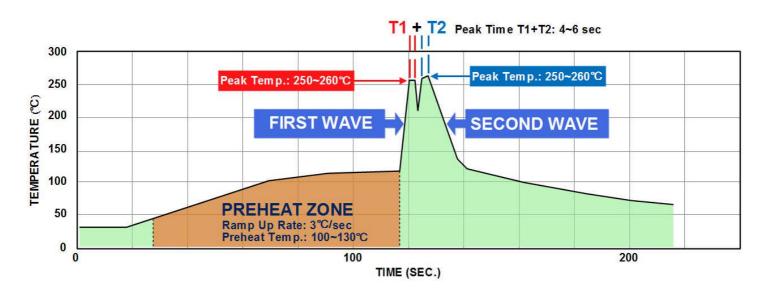
PXC-M03-xxDxx Type B



- . All dimensions in Inch (mm)
 Tolerance: X.XX±0.02 (X.X±0.5)
 X.XXX±0.01 (X.XX±0.25)
- 2. Pin pitch tolerance ±0.01 (0.25)
- 3. Pin dimension tolerance ±0.004 (0.1)

Soldering Considerations

Lead free wave solder profile



 $Reference\ Solder\ \colon\ Sn\text{-}Ag\text{-}Cu\ ;\ Sn\text{-}Cu$

Hand Soldering (Reference):
Soldering iron: Power 150W
Soldering time: 3~6 sec
Temp: 410~430°C



Packaging Information

Tube

10pcs converters in a Tube All dimensions in inches (mm)

Part Number Structure

PXC-M03 Series Name	-	48 Input Voltage (VDC)	Output Quantity	05 Output Voltage (VDC)	Pin Connection Option	Remote On/Off Option	Trim Option
		05 : 4.5~9 12 : 9~18 24 : 18~36 48 : 36~75	S: Single	3P3: 3.3 05: 5 12: 12 15: 15 24: 24	A : A type □: B type	: No On/Off control P: Remote On/Off (Only for B type Pin connection)	☐: No Trim T: Trim (Only for B type Pin connection)
			D : Dual	05 : ±5 12 : ±12			

15: ±15

Model Number	Input Range	Output Voltage	Output Current @Full Load	Input Current @ No Load	Efficiency	Maximum Capacitor Load
	VDC	VDC	mA	mA	%	μF
PXC-M03-05D05A/□		±5	±300	25	83	±430
PXC-M03-05D12A/□	4.5 ~ 9	±12	±125	25	86	±75
PXC-M03-05D15A/□		±15	±100	25	86	±56
PXC-M03-12D05A/□		±5	±300	10	83.5	±430
PXC-M03-12D12A/□	9 ~ 18	±12	±125	10	87.5	±75
PXC-M03-12D15A/□		±15	±100	10	86.5	±56
PXC-M03-24D05A/□		±5	±300	6	83	±430
PXC-M03-24D12A/□	18 ~ 36	±12	±125	6	87	±75
PXC-M03-24D15A/□		±15	±100	6	86	±56
PXC-M03-48D05A/□		±5	±300	4	83	±430
PXC-M03-48D12A/□	36 ~ 75	±12	±125	4	86	±75
PXC-M03-48D15A/□		±15	±100	4	86	±56

Safety and Installation Instructions

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. For maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. See suggested values below:

Model	Fuse Rating (A)	Fuse Type
PXC-M03-05Dxx	1.25	Slow-Blow
PXC-M03-12Dxx	0.63	Slow-Blow
PXC-M03-24Dxx	0.315	Slow-Blow
PXC-M03-48Dxx	0.315	Slow-Blow

Based on the information provided in this data sheet on inrush energy and maximum dc input current at low Vin.

MTBF and Reliability

The MTBF has been calculated using:

MIL-HDBK 217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 6.444×10⁶ hours.